

PCN – Ardentec Drop Shipment Packing Change

Zilog Authorized Distribution

Zilog, Inc. 1590 Buckeye Drive Milpitas, CA 95035-7418

November 14, 2019

Subject: Ardentec Drop Shipment Packing Change

Dear Valued Customer:

As previously communicated, Ardentec Corp. (Taiwan) is qualified for drop shipment of Zilog MCU products.

The packing materials/method from Ardentec have changed slightly. Refer to the following page for pictures of the packing differences.

Should you have questions regarding this matter or need additional assistance, please contact <u>zservice@zilog.com</u>.

Thank you for your continued interest in Zilog products and services.

Sincerely,

Sonia Daley sdaley7@littelfuse.com Director of Reliability and Quality Zilog- a Littelfuse Company

ZAC19-0040



PCN – Ardentec Drop Shipment Packing Change

Zilog Authorized Distribution

FROM:

before packing in aluminum bag

TO:

Trays wrapped in anti-static foam Trays wrapped in bubble wrap before packing in aluminum bag.



FROM:

Zilog logo on shipping box.





ZAC19-0040







